PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT		
NATURE OF CONVEYANCE:	ASSIGNMENT		
CONVEYING PARTY DATA			
Name		Execution Date	
Akinobu HAYAKAWA	WA		
Hideaki ISHIZAWA	/A		
Kohei TAKEDA		03/30/2010	
Ryohei MASUI		03/30/2010	
RECEIVING PARTY DATA Name: SEKISUI CHEMI Street Address: 4-4, Nishitemma	CAL CO., LTD. 2-chome, Kita-ku, Osaka-shi,		
	Osaka		
State/Country: JAPAN			
	530-8565		
Property Type	e Number		
Application Number: 126	69081		
CORRESPONDENCE DATA			
Fax Number: (202)721-8250			
Correspondence will be sent via US Mail when the fax attempt is unsuccessful.Phone:2027218200			
Email: wlp@wenderoth.com			
Correspondent Name: WENDEROTH, LIND & PONACK, LLP			
Address Line 1: 1030 15th Street, N.W. Address Line 2: Suite 400 East			
	DISTRICT OF COLUMBIA 20005		
ATTORNEY DOCKET NUMBER:	TORNEY DOCKET NUMBER: 2009_1996A		
NAME OF SUBMITTER:	Donna King		
Total Attachments: 2		PATENT	

NO. 093408 P. 5/63 5464505

ASSIGNMENT

In consideration of the sum of One Dollar (\$1.00) and other good and valuable consideration paid to each of the undersigned

Akinobu HAYAKAWA Insert Name(s) Hideaki ISHIZAWA of Inventor(s) Kohei TAKEDA Rvohei MASUI the undersigned hereby sell(s) and assign(s) to Insert Numers) SEKISUI CHEMICAL CO., LTD. of Assignee(s) of 4-4, Nishitemma 2-chome, Kita-ku, Osaka-shi, Osaka 530-8565, Japan Addreu (hereinafter designated as the Assignee) the entire right, title and interest for the United States as defined in 35 USC 100, in the invention known as

ADHESIVE FOR ELECTRONIC COMPONENT

for which an application for patent in the United States has been executed by the undersigned on

The undersigned agree(s) to execute all papers necessary in connection with this application and any continuing, divisional or reissue applications thereof and also to execute separate assignments in connection with such applications as the Assignce may deem necessary or expedient.

The undersigned agree(s) to execute all papers necessary in connection with any interference which may be declared concerning this application or continuation, division or reissue thereof and to cooperate with the Assignce in every way possible in obtaining evidence and going forward with such interference.

The undersigned agree(s) to execute all papers and documents and perform any act which may be necessary in connection with claims or provisions of the International Convention for Protection of Industrial Property or similar agreements.

The undersigned agree(s) to perform all affirmative acts which may be necessary to obtain a grant of a valid United States patent to the Assignee.

The undersigned hereby authorize(s) and request(s) the Commissioner of Patents to issue any and all Letters Patents of the United States resulting from said application or any division or divisions or continuing or reissue applications thereof to the said Assignee, as Assignce of the entire interest, and hereby covenants that he has (they have) full right to convey the entire interest herein assigned, and that he has (they have) not executed, and will not execute, any agreement in conflict herewith.

Title of Invention

Date of **Bigning** of Application

> PATENT REEL: 024204 FRAME: 0786

2010年 3月31日 0時21分

SK645US

The undersigned hereby grant(s) the firm of WENDEROTH, LIND & PONACK, L.L.P., 1030 15th Street, N.W., Suite 400 East, Washington, D.C. 20005-1503, the power to insert on this assignment any further identification which may be necessary or desirable in order to comply with the rules of the United States Patent Office for recordal of this document.

In witness whereof, executed by the undersigned on the date(s) opposite the undersigned name(s).

MAR. 30, 2010	Akinbu Hayakawa
	Akinobu HAYAKAWA
MAR. 30.2010	Hideaki Ishizawa
MAR. 30.2010	Hideaki ISHIZAWA Kohel TAKEDA
MAR. 3 0. 2010	Kohei TAKEDA Ryohei Masui Ryohei MASUI
	MAR. 30, 2010 MAR. 30, 2010

The above application may be more particularly identified as follows:

U.S. Application Serial No.:

Filing Date: _____

Applicant Reference Number: SK645US

Attorney Docket No.: 2009_1996A

Title of Invention ADHESIVE FOR ELECTRONIC COMPONENT

PATENT REEL: 024204 FRAME: 0787

RECORDED: 04/08/2010